

Product data Supersedes data of 2000 Jun 19 2002 Dec 13



PHILIP

GTL16612

FEATURES

- 18-bit bidirectional bus interface
- Translates between GTL/GTL+ logic levels (B ports) and LVTTL/TTL logic levels (A ports)
- 5 V I/O tolerant on the LVTTL/TTL side (A ports)
- No bus current loading when LVTTL/TTL output is tied to 5 V bus
- 3-State buffers
- Output capability: +64 mA/-32 mA on the LVTTL/TTL side (A ports); +40 mA on the GTL/GTL+ side (B ports)
- TTL input levels on control pins
- Power-up reset
- Power-up 3-State
- Positive edge triggered clock inputs
- Latch-up protection exceeds 500 mA per JESD78
- ESD protection exceeds 2000 V HBM per JESD22-A114, 200 V MM per JESD22-A115 and 1000 V CDM per JESD22-C101

QUICK REFERENCE DATA

DESCRIPTION

The GTL16612 is a high-performance BiCMOS product designed for V_{CC} operation at 3.3 V with I/O compatibility up to 5 V.

This device is an 18-bit universal transceiver featuring non-inverting 3-State bus compatible outputs in both send and receive directions. Data flow in each direction is controlled by output enable (OEAB and OEBA), latch enable (LEAB and LEBA), and clock (CPAB and CPBA) inputs. For A-to-B data flow, the device operates in the transparent mode when LEAB is High. When LEAB is Low, the A data is latched if CPAB is held at a High or Low logic level. If LEAB is Low, the A-bus data is stored in the latch/flip-flop on the Low-to-High transition of CPAB. When OEAB is Low, the outputs are active. When OEAB is High, the outputs are in the high-impedance state. The clocks can be controlled with the clock-enable inputs (CEBA/CEAB).

Data flow for B-to-A is similar to that of A-to-B but uses OEBA, LEBA and CPBA.

SYMBOL	DADAMETED	CONDITIONS	TYPICAL	
STWBUL	PARAMETER	T _{amb} = 25 ℃	3.3 V	UNIT
t _{PLH} t _{PHL}	Propagation delay An to Bn or Bn to An	C _L = 50 pF	1.9	ns
C _{IN}	Input capacitance (Control pins)	$V_I = 0 V \text{ or } V_{CC}$	4	pF
C _{I/O}	I/O pin capacitance	Outputs disabled; $V_{I/O} = 0 V \text{ or } V_{CC}$	8	pF
I _{CCZ}	Total supply current	Outputs disabled	12	mA

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	ORDER CODE	DWG NUMBER
56-Pin Plastic SSOP	-40 to +85 °C	GTL16612DL	SOT371-1
56-Pin Plastic TSSOP	-40 to +85 °C	GTL16612DGG	SOT364-1

Standard packing quantities and other packaging data is available at www.philipslogic.com/packaging.

Product specification

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PIN CONFIGURATION



PIN DESCRIPTION

PIN NUMBER	SYMBOL	NAME AND FUNCTION
1, 27	OEAB/OEBA	A-to-B/ B-to-A Output enable input (active Low)
29, 56	CEBA/CEAB	B-to-A/A-to-B clock enable
2, 28	LEAB/LEBA	A-to-B/B-to-A Latch enable input
55,30	CPAB/CPBA	A-to-B/B-to-A Clock input (active rising edge)
3, 5, 6, 8, 9, 10, 12, 13, 14, 15, 16, 17, 19, 20, 21, 23, 24, 26	A0-A17	Data inputs/outputs (A side)
54, 52, 51, 49, 48, 47, 45, 44, 43, 42, 41, 40, 38, 37, 36, 34, 33, 31	B0-B17	Data inputs/outputs (B side)
4, 11, 18, 25, 32, 39, 46, 53	GND	Ground (0 V)
7, 22	V _{CC}	Positive supply voltage
35	V _{REF}	GTL reference voltage
50	NC	No connection

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LOGIC SYMBOL (Positive Logic)



FUNCTION TABLE

	OUTPUT				
CEAB ¹	OEAB ¹	LEAB ¹	CPAB ¹	Α	В
Х	Н	Х	Х	Х	Z
Х	L	Н	Х	L	L
Х	L	Н	Х	Н	Н
Н	L	L	Х	Х	В _О 2
Н	L	L	Х	Х	B _O ²
L	L	L	\uparrow	L	L
L	L	L	\uparrow	Н	Н
L	L	L	Н	Х	B _O ²
L	L	L	L	Х	B _O ³

X = Don't care

H = High voltage level

L = Low voltage level

 \uparrow = Low to High

Z = High impedance "off" state

1. A-to-B data flow is shown: B-to-A flow is similar but uses OEBA, LEBA, CPBA, and CEBA.

2. Output level before the indicated steady-state input conditions were established.

3. Output level before the indicated steady-state input conditions were established, provided that CPAB was Low before LEAB went Low.

ABSOLUTE MAXIMUM RATINGS 1, 2

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT	
V _{CC}	DC supply voltage		-0.5 to +4.6	V	
I _{IK}	DC input diode current	V ₁ < 0	-50	mA	
V	DC input voltage3	A port	-0.5 to +7.0	V	
VI	DC Input voltage	B port	-0.5 to +4.6		
I _{ОК}	DC output diode current	V _O < 0; A port	-50	mA	
N	DC output voltogra	Output in Off or High state; A port	-0.5 to +7.0	V	
٧O	DC output voltage	Output in Off or High state; B port	-0.5 to +4.6	V	
	Current into any output in the LOW state	A port	128	mA	
'OL	Current into any output in the LOW state	B port	80	mA	
I _{OH}	Current into any output in the HIGH state	A port	-64	mA	
T _{stg}	Storage temperature range		-65 to +150	°C	

NOTES:

1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.

2.

3. The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

RECOMMENDED OPERATING CONDITIONS

CYMDOL	DADAMETED	TEST CONDITIONS	3.3 V RAN			
STMBOL	PARAMETER	TEST CONDITIONS	MIN	MAX		
V _{CC}	DC supply voltage		3.0	3.6	V	
N		GTL	1.14	1.26	N	
VTT	Termination voltage	GTL ⁺	1.35	1.65	V	
N		GTL	0.74	0.87	N/	
VREF	GTL reference voltage	GTL ⁺	0.9	1.10	V	
. <i></i>		B port	0	V _{TT}	v	
VI	Input voltage	Except B port	0	5.5		
N		B port	V _{REF} +50 mV		N	
VIH	HIGH-level input voltage	Except B port	2.0		v	
N		B port		V _{REF} -50 mV		
VIL	LOW-level input voltage	Except A port		0.8	V	
I _{OH}	HIGH-level output current	A port		-32	mA	
		B port		40	0	
IOL	LOvv-ievel output current	A port		64	MA	
T _{amb}	Operating free-air temperature range		-40	+85	°C	

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DC ELECTRICAL CHARACTERISTICS (3.3 V ± 0.3 V RANGE)

SYMBOL	. PARAMETER		TEST CONDI	TEST CONDITIONS		Temp = -40 to +85 °C			
		F			MIN	TYP ¹	MAX		
V _{IK}	Input clamp vo	ltage	V _{CC} = 3.0 V; I _{IK} = -18 mA			-0.85	-1.2	V	
N/	Link lavel aver	talta ara	V_{CC} = 3.0 to 3.6 V; I_{OH} = -100 μA	A mant	V _{CC} -0.2	V _{CC}		N	
∨он	Hign-level outp	out voltage	V _{CC} = 3.0 V; I _{OH} = -32 mA	А роп	2.0	2.3		V	
			$V_{CC} = 3.0 \text{ V}; \text{ I}_{OL} = 100 \mu\text{A}$			0.07	0.2		
			V _{CC} = 3.0 V; I _{OL} = 16 mA	A nort		0.25	0.4		
V _{OL}	Low-level outp	out voltage	V _{CC} = 3.0 V; I _{OL} = 32 mA	А роп		0.3	0.5	V	
			V _{CC} = 3.0 V; I _{OL} = 64 mA			0.4	0.55		
			V _{CC} = 3.0 V; I _{OL} = 40 mA	B port		0.4	0.5	V	
			V_{CC} = 3.6 V; V_{I} = V_{CC} or GND	O satural arises		0.1	±1		
			$V_{CC} = 0 \text{ or } 3.6 \text{ V}; \text{ V}_{I} = 5.5 \text{ V}$	Control pins		0.1	10	μΑ	
			$V_{CC} = 3.6 \text{ V}; \text{ V}_{I} = 5.5 \text{ V}$			0.1	20		
I _I Input leakage current	current	$V_{CC} = 3.6 \text{ V}; \text{ V}_{I} = V_{CC}$	I/O Data pins ⁴		0.5	10	μΑ		
			$V_{CC} = 3.6 V; V_{I} = 0$, npon		0.1	-5		
			V_{CC} = 3.6 V; V_{I} = V_{TT} or GND	B port			±5	μΑ	
I _{OFF}	Output off curr	ent	V_{CC} = 0 V; V _I or V _O = 0 to 4.5 V	-		0.1	±100	μΑ	
	Due Held sum		$V_{CC} = 3 \text{ V}; \text{ V}_{I} = 0.8 \text{ V}$		75	130			
HOLD	Bus Hold curre	ent, A outputs	$V_{CC} = 3 \text{ V}; \text{ V}_{I} = 2.0 \text{ V}$		-75	-140		μΑ	
I _{EX}	Current into an High state whe	n output in the en V _O > V _{CC}	V _O = 5.5 V; V _{CC} = 3.0 V	A port		10	125	μΑ	
I _{PU/PD}	Power up/down	n 3-State	$\frac{V_{CC} \le 1.2 \text{ V}; \text{ V}_{O} = 0.5 \text{ V to } V_{CC}; \text{ V}}{\overline{OE} = \text{Don't care}}$	I = GND or V _{CC}		1.0	±100	μΑ	
ICCH			Outputs high			5.0	9.0		
I _{CCL}	A-Port		Outputs low			10.5	18.5		
I _{CCZ} ⁵		V _{CC} = 3.6 V	Disabled	$V_I = GND \text{ or } V_{CC}, I_O = 0$		6.0	11.5	mA	
I _{CCH}	D. Dt		Outputs high			9.7	17.5	-	
I _{CCL}	B-Port		Outputs low	1		7.0	12.0		
ΔI_{CC}	Additional supplication of the second	ply current per	V_{CC} = 3 V to 3.6 V; One input at V Other inputs at V _{CC} or GND	_{CC} -0.6 V,		0.04	0.2	mA	

NOTES:

1. All typical values are at $V_{CC} = 3.3$ V and $T_{amb} = 25$ °C. 2. This is the increase in supply current for each LVTTL input at the specified voltage level other than V_{CC} or GND 3. This parameter is valid for any V_{CC} between 0 V and 1.2 V with a transition time of up to 10 msec. From $V_{CC} = 1.2$ V to $V_{CC} = 3.3$ V ± 0.3 V a transition time of 100 μ sec is permitted. This parameter is valid for T_{amb} = 25°C only.

4. Unused pins at V_{CC} or GND.

5. I_{CCZ} is measured with outputs pulled up to V_{CC} or pulled down to ground.

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AC CHARACTERISTICS (A PORT)

GND = 0 V; t_r = t_f = 2.5 ns; C_L = 50 pF; R_L = 500 Ω ; T_{amb} = -40 to +85 °C.

			GTL						
	GTL16612 An Po	rt	V _{CC} = 3.3 V ±0.3 V			V _{CC} = 3.3 V ±0.3 V			
			V _{REF} = 0.8 V			١	/ _{REF} = 1.0 V	/	UNIT
SYMBOL	PARAMETER	WAVEFORM	MIN	TYP ¹	MAX	MIN	TYP ¹	MAX	
t _{PLH}	Bn to An	2	1.6	3.0	5.0	1.6	3.0	5.0	ns
t _{PHL}	Bn to An	2	3.0	4.9	6.3	3.0	4.9	6.3	ns
t _{PLH}	LEBA to An	3	1.6	2.7	4.2	1.6	2.7	4.2	ns
t _{PHL}	LEBA to An	3	1.6	2.8	4.3	1.6	2.8	4.3	ns
t _{PLH}	CPBA to An	1	1.9	3.4	4.7	1.9	3.4	4.7	ns
t _{PHL}	CPBA to An	1	1.8	3.8	5.2	1.8	3.8	5.2	ns
t _{PZH}	OEBA to An	5	1.5	2.6	4.2	1.5	2.6	4.2	ns
t _{PHZ}	OEBA to An	5	1.4	2.9	4.8	1.4	2.9	4.8	ns
t _{PZL}	OEBA to An	6	1.3	2.4	3.8	1.3	2.4	3.8	ns
t _{PLZ}	OEBA to An	6	1.2	2.2	3.5	1.2	2.2	3.5	ns

NOTE:

1. Typical values are at V_{CC} = 3.3 V, T_{amb} = +25 °C.

AC CHARACTERISTICS (B PORT)

GND = 0 V; $t_r = t_f = 2.5 \text{ ns}$; $C_L = 30 \text{ pF}$; $R_L = 25 \Omega$; $T_{amb} = -40 \text{ to } +85 \text{ °C}$.

			GTL			GTL+			
	GTL16612 Bn Po	rt	Vcc	; = 3.3 V ±0.	3 V	V _{CC} = 3.3 V ±0.3 V			
			V _{REF} = 0.8 V			V _{REF} = 1.0 V			UNIT
SYMBOL	PARAMETER	WAVEFORM	MIN	TYP ¹	MAX	MIN	TYP ¹	MAX	
t _{PLH}	An to Bn	2	1.4	2.4	3.7	1.3	2.4	3.7	ns
t _{PHL}	An to Bn	2	1.3	2.5	4.0	1.4	2.6	4.2	ns
t _{PLH}	LEAB to Bn	3	1.7	3.0	4.4	1.8	3.0	4.6	ns
t _{PHL}	LEAB to Bn	3	2.1	3.5	5.4	2.3	3.6	5.5	ns
t _{PLH}	CPAB to Bn	1	1.8	3.1	4.5	1.9	3.1	4.8	ns
t _{PHL}	CPAB to Bn	1	2.3	3.6	5.4	2.4	3.8	5.8	ns
t _{PLH}	OEAB to Bn	7	1.1	2.1	3.3	1.4	2.0	3.5	ns
t _{PHL}	OEAB to Bn	7	1.6	2.8	4.4	1.0	2.9	4.5	ns

NOTE:

1. Typical values are at V_{CC} = 3.3 V, T_{amb} = +25 °C.

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AC SETUP REQUIREMENTS (3.3 V ±0.3 V RANGE)

A Port: GND = 0 V; Input $t_r = t_f = 2.5 \text{ ns}$; $C_L = 50 \text{ pF}$; $R_L = 500 \Omega$; $T_{amb} = -40 \text{ to } +85 \text{ °C}$; $V_{REF} = 0.8 \text{ V or } 1.0 \text{ V}$. B Port: GND = 0 V; Input $t_r = t_f = 2.5 \text{ ns}$; $C_L = 30 \text{ pF}$; $R_L = 25 \Omega$; $V_{REF} = 0.8 \text{ V or } 1.0 \text{ V}$.

			LIM	UNIT	
SYMBOL	PARAMETER	WAVEFORM	V _{CC} = 3.3		
			MIN	MAX	
t _s (H)	Setup time, High or Low	4	1.5		ns
t _s (L)	Bn to CPBA	4	1.5		ns
t _s (H)	Setup time, High or Low	4	2.0		ns
t _s (L)	An to CPAB	4	3.0		ns
t _h (H)	Hold time, High or Low	4	1.0		ns
t _h (L)	Bn to CPBA, or An to CPAB	4	1.0		ns
t _s (H)	Setup time, High or Low	4	1.0		ns
t _s (L)	Bn to LEBA, or An to LEAB	4	1.0		ns
t _h (H)	Hold time, High or Low	4	1.5		ns
t _h (L)	Bn to LEBA, or An to LEAB	4	1.5		ns
t _s (H)	Setup time, High or Low	4	1.0		ns
t _s (L)	CEAB to CPAB, or CEBA to CPBA	4	1.0		ns
t _h (H)	Hold time, High or Low	4	1.5		ns
t _h (L)	CEAB to CPAB, or CEBA to CPBA	4	1.0		ns
t _w (H)	Pulse width, High or Low	4	2.0		ns
t _w (L)	CPBA or CPAB	4	2.0		ns
t _w (H)	Pulse width, High LEBA or LEAB	3	1.5		ns

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AC WAVEFORMS

 $V_M = 1.5 \text{ V}$ at $V_{CC} \ge 3.0 \text{ V}$. $V_M = 1.5 \text{ V}$ for A ports and control pins; $V_M = 0.8 \text{ V}$ for B ports in GTL mode; $V_M = 1.0 \text{ V}$ for B ports in GTL+ mode. $V_X = V_{OL} + 0.3 \text{ V}$ at $V_{CC} \ge 3.0 \text{ V}$.



Waveform 1. Propagation delay, clock input to output, clock pulse width, and maximum clock frequency



Waveform 2. Propagation delay, transparent mode



Waveform 3. Propagation delay, enable to output, and enable pulse width



Waveform 4. Data setup and hold times



Waveform 5. 3-State output enable time to high level and output disable time from high level



Waveform 6. 3-State output enable time to low level and output disable time from low level



Waveform 7. Output enable time on open collector output with pullup

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TEST CIRCUIT



SW00255

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REVISION HISTORY

Rev	Date	Description
_4	20021213	Product data (9397 750 10862); ECN 853-2166 29245 of 03 December 2002
		Modifications:
		 New package release.
_3	20000619	Product data (9397 750 07217); ECN 853-2166 23903 of 19 June 2000.

Data sheet status

Level	Data sheet status ^[1]	Product status ^{[2] [3]}	Definitions
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
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[3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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